

Please note that Cypress is an Infineon Technologies Company.

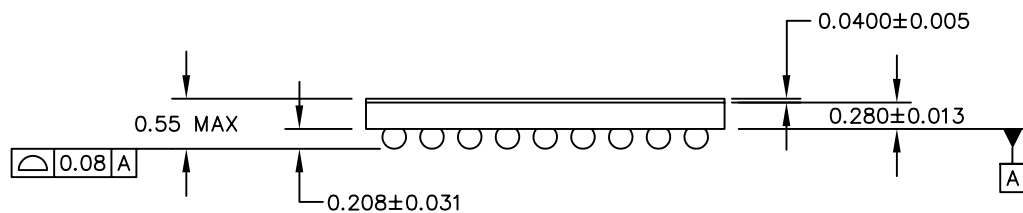
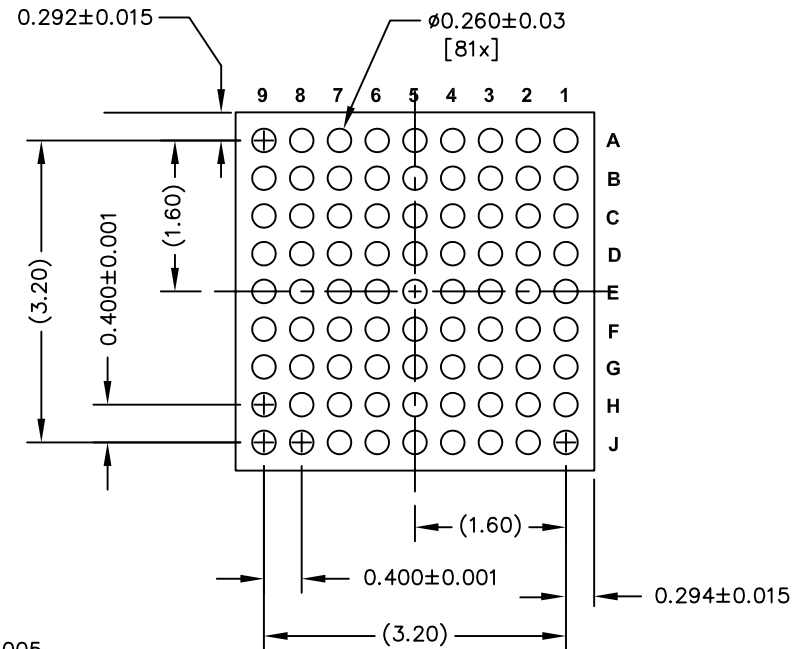
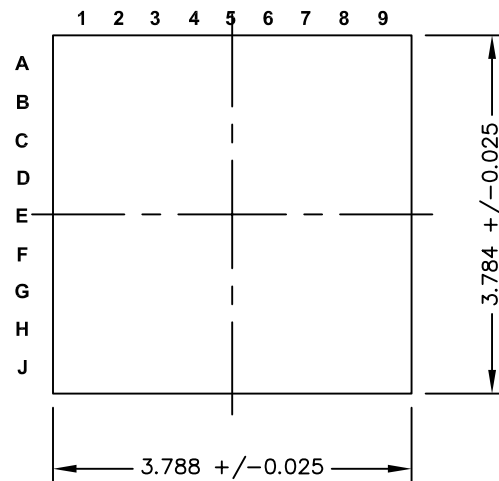
The document following this cover page is marked as “Cypress” document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

Continuity of document content


The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

Continuity of ordering part numbers

Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.



ALL DIMENSIONS ARE IN MM
 PACKAGE WEIGHT ~ 0.015gr
 JEDEC - Publication 95; Design Guide 4.18


 CYPRESS Company Confidential	
TITLE PACKAGE OUTLINE, 81B ANTIOCH WLCSP 3.8X3.8X0.55 MM FN81A/FY81A	
SPEC NO. 001-13820	REV *G
SCALE	SHEET 1 OF 2

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PACKAGE
 CODE(S)

FN81A/
 FY81A

Rev	ECN No.	Orig. of change	Description of Change
**	867542	MLA	NEW SPEC
*A	1067002	MLA	CORRECT BUMP DIA, BUMP HEIGHT, AND DIE SIZE DIMENSIONS. ADD CORRECT BUMP DIA, BUMP HEIGHT, AND DIE SIZE DIMENSIONS. ADD
*B	1112143	MLA	ADD PACKAGE WEIGHT AND JEDEC DRAWING REFERENCE.
*C	2791906	MLA	REDRAWN IN NEW TEMPLATE. RENAME DOCUMENT TITLE. CHANGE PART NO. FROM FN81 TO FN81A/FY81A. ADDED SIZE. CHANGED LAMINATE THICKNESS FROM 0.0400+/-0.005 TO 0.022+/-0.005. REMOVED MARKERS A AND B. CHANGED MARKER C TO A.
*D	2812921	TZWTMP3	CHANGE TEMPLATE, CHANGE TITLE FROM PACKAGE OUTLINE, 81B ANTIOCH WLCSP FN81A/FY81A TO PACKAGE OUTLINE, 81B ANTIOCH WLCSP 3.8X3.8X0.55 MM
*E	2909733	CMG	FN81A/FY81A CHANGED LAMINATE THICKNESS FROM 0.022+/-0.005 TO 0.0400+/-0.005
*F	3581874	EDCA	NO CHANGE, SUNSET REVIEW.
*G	4752490	ROWI	SUNSET REVIEW, CHANGED DRAWING TEMPLATE.

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SCALE	SHEET 2 OF 2

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